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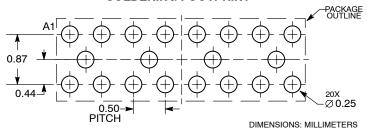
NOTES:

- O LU:

 1. DIMENSIONING AND TOLERANCING PER
 ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.56	0.65	
A1	0.21	0.27	
A2	0.40 REF		
b	0.29	0.35	
D	4.00 BSC		
E	1.46 BSC		
eD	0.50 BSC		
۵F	0.435 BSC		

RECOMMENDED **SOLDERING FOOTPRINT***



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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